

IN THE CLAIMS

Please cancel claims 1-19 and 32-40 without prejudice.

1-19. Canceled

20. (original) A packaged capacitor comprising:

- a substrate;

- a thin film over part of the substrate;

- an insulating layer deposited over the entire substrate;

- posts on the insulating layer;

- a first conductive layer laid over the insulating layer, and extending to a top of a first post; and

- a second conductive layer, in contact with the thin film and extending to the top of a second post.

21. (original) The packaged capacitor of claim 20, further comprising:

- a second insulating layer deposited over the first and second conductive layers, covering the first and second conductive layers, except at the top of the first and second post.

22. (original) The packaged capacitor of claim 20, wherein the first conductive layer is substantially parallel to the thin film, the thin film, the insulating layer and the first conductive layer together forming the packaged capacitor.

23. (original) The packaged capacitor of claim 20, further comprising:

- a third insulating layer on the substrate and underneath the thin film.

24. (original) The packaged capacitor of claim 20, further comprising:

- a protective layer on the conductive layer exposed on the tops of the posts.

25. (currently amended) The packaged capacitor of claim 20, wherein the thin film is ~~[insert one or more materials]~~made of one or more of the materials including tantalum nitride, nichrome, or tin oxide.

26. (original) The packaged capacitor of claim 20, wherein the first insulating layer is a polyimide layer which provides compliancy to the packaged capacitor.

27. (original) The packaged capacitor of claim 20, wherein the posts are made of one or more of the materials including: silicon, gallium arsenide, silicon germanium, silicon carbide, gallium phosphide, ceramic materials, sapphire quartz, polymer plastic, patterned plastic, epoxy, glass, Teflon, silicon dioxide, or polysilicon.

28. (original) The packaged capacitor of claim 20, wherein the conductive layer is gold.

29. (original) The packaged capacitor of claim 22, wherein the second insulating layer is of polyimide which provides compliancy to the packaged capacitor.

30. (original) The packaged capacitor of claim 23, wherein the third insulating layer is of polyimide, which provides compliancy to the packaged capacitor.

31. (original) The packaged capacitor of claim 24, wherein the protective layer comprises a first layer of nickel and a second layer of flash gold.

32-40. Canceled.